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74LVT373 3.3 V octal D-type transparent latch; 3-state Rev. 3 – 21 November 2011

**Product data sheet** 

### 1. General description

The 74LVT373 is a high-performance BiCMOS product designed for V<sub>CC</sub> operation at 3.3 V. This device is an octal transparent latch coupled to eight 3-state output buffers. The two sections of the device are controlled independently by latch enable (LE) and output enable ( $\overline{OE}$ ) control gates. The data on the Dn inputs are transferred to the latch outputs when the latch enable (LE) input is HIGH. The latch remains transparent to the data inputs while LE is HIGH, and stores the data that is present one setup time before the HIGH-to-LOW enable transition.

The 3-state output buffers are designed to drive heavily loaded 3-state buses, MOS memories, or MOS microprocessors. The active-low output enable  $(\overline{OE})$  controls all eight 3-state buffers independent of the latch operation.

When  $\overline{OE}$  is LOW, the latched or transparent data appears at the outputs. When  $\overline{OE}$  is HIGH, the outputs are in the high-impedance OFF-state, which means they will neither drive nor load the bus.

The 74LVT373 is functionally identical to the 74LVT573, but has a different pin arrangement.

### 2. Features and benefits

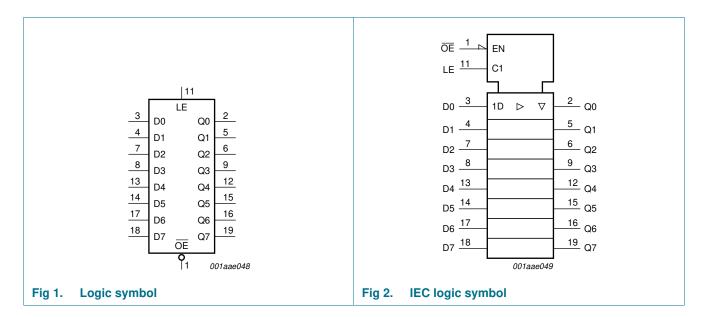
- Inputs and outputs arranged for easy interfacing to microprocessors
- 3-state outputs for bus interfacing
- Common output enable control
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- No bus current loading when output is tied to 5 V bus
- Power-up reset
- Power-up 3-state
- Latch-up protection
  - JESD78 class II exceeds 500 mA
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from –40 °C to +85 °C

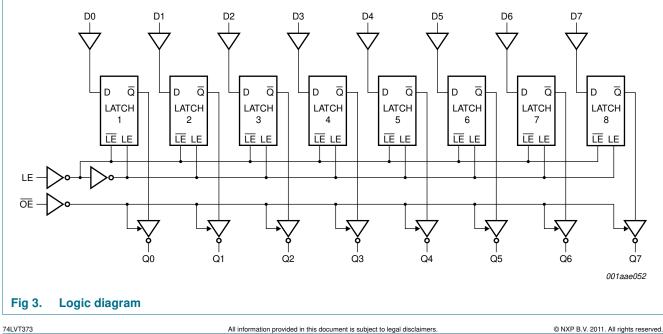


## 3. Ordering information

| Table 1. Orde       | Table 1. Ordering information |         |   |          |  |  |  |  |
|---------------------|-------------------------------|---------|---|----------|--|--|--|--|
| Type number Package |                               |         |   |          |  |  |  |  |
|                     | Temperature range             | Name    | Description   | Version  |  |  |  |  |
| 74LVT373D           | –40 °C to +85 °C              | SO20    | plastic small outline package; 20 leads;<br>body width 7.5 mm             | SOT163-1 |  |  |  |  |
| 74LVT373PW          | –40 °C to +85 °C              | TSSOP20 | plastic thin shrink small outline package; 20 leads;<br>body width 4.4 mm | SOT360-1 |  |  |  |  |

## 4. Functional diagram

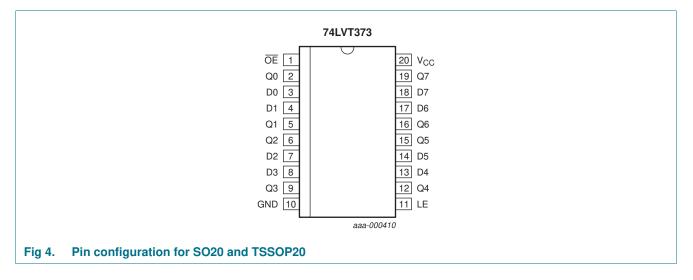




3.3 V octal D-type transparent latch; 3-state

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

| Table 2.        | Pin description            |                                  |
|-----------------|----------------------------|----------------------------------|
| Symbol          | Pin                        | Description                      |
| OE              | 1                          | output enable input (active LOW) |
| D0 to D7        | 3, 4, 7, 8, 13, 14, 17, 18 | data input                       |
| GND             | 10                         | ground (0 V)                     |
| LE              | 11                         | latch enable (active HIGH)       |
| Q0 to Q7        | 2, 5, 6, 9, 12, 15, 16, 19 | data output                      |
| V <sub>CC</sub> | 20                         | supply voltage                   |

## 6. Functional description

### 6.1 Function table

#### Table 3. Function table [1]

| Operating mode          | Control OE | Control LE   | Input Dn | Internal regis | ster Output Qn |
|-------------------------|------------|--------------|----------|----------------|----------------|
| Load and read register  | L          | Н            | L        | L              | L              |
| enable                  |            |              | Н        | Н              | Н              |
| Latch and read register | L          | $\downarrow$ | I        | L              | L              |
|                         |            |              | h        | Н              | Н              |
| Hold                    | L          | L            | Х        | NC             | NC             |
| Disable outputs         | Н          | L            | Х        | NC             | Z              |
|                         |            | Н            | Dn       | Dn             | Z              |

[1] H = HIGH voltage level;

L = LOW voltage level;

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74LVT373

 $\downarrow$  = HIGH-to-LOW latch enable transition;

h = HIGH voltage level one setup time prior to the LOW-to-HIGH clock transition;

I = LOW voltage level one setup time prior to the LOW-to-HIGH clock transition;

Z = high-impedance OFF-state;

NC = no change;

X = don't care.

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min             | Max  | Unit |
|------------------|-------------------------|--|-----------------|------|------|
| V <sub>CC</sub>  | supply voltage          |  | -0.5            | +4.6 | V    |
| VI               | input voltage           |  | <u>[1]</u> –0.5 | +7.0 | V    |
| Vo               | output voltage          | output in OFF-state or HIGH-state                  | <u>[1]</u> –0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                               | -               | -50  | mA   |
| I <sub>OK</sub>  | output clamping current | $V_{\rm O} < 0 \ V$                                | -               | -50  | mA   |
| lo               | output current          | output in LOW-state                                | -               | 128  | mA   |
|                  |                         | output in HIGH-state                               | -               | -64  | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65             | +150 | °C   |
| Tj               | junction temperature    |  | [2] _           | 150  | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$ | <u>[3]</u>      | 500  | mW   |

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K. For TSSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

| Symbol                | Parameter                           | Conditions                                       | Min | Тур | Max | Unit |
|-----------------------|-------------------------------------|--|-----|-----|-----|------|
| V <sub>CC</sub>       | supply voltage                      |  | 2.7 | -   | 3.6 | V    |
| VI                    | input voltage                       |  | 0   | -   | 5.5 | V    |
| V <sub>IH</sub>       | HIGH-level input voltage            |  | 2.0 | -   | -   | V    |
| V <sub>IL</sub>       | LOW-level input voltage             |  | -   | -   | 0.8 | V    |
| I <sub>OH</sub>       | HIGH-level output current           |  | -   | -   | -32 | mA   |
| l <sub>OL</sub>       | LOW-level output current            |  | -   | -   | 32  | mA   |
|                       |                                     | current duty cycle $\leq 50$ %; $f_i \geq 1~kHz$ | -   | -   | 64  | mA   |
| T <sub>amb</sub>      | ambient temperature                 | in free air                                      | -40 | -   | +85 | °C   |
| $\Delta t / \Delta V$ | input transition rise and fall rate | outputs enabled                                  | -   | -   | 10  | ns/V |
|                       |                                     |  |     |     |     |      |

#### 3.3 V octal D-type transparent latch; 3-state

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                             | Conditions  |            | T <sub>amb</sub> =    | –40 °C to +          | 85 °C | Unit |  |
|---------------------|---------------------------------------|---|------------|-----------------------|----------------------|-------|------|--|
|                     |                                       |   |            | Min                   | Typ <mark>[1]</mark> | Max   |      |  |
| V <sub>IK</sub>     | input clamping voltage                | $V_{CC}$ = 2.7 V; I <sub>IK</sub> = -18 mA  |            | -1.2                  | -0.9                 | -     | V    |  |
| V <sub>OH</sub>     | HIGH-level output voltage             | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$<br>$I_{OH} = -100 \mu\text{A}$  |            | V <sub>CC</sub> – 0.2 | $V_{CC}-0.1$         | -     | V    |  |
|                     |                                       | $V_{CC} = 2.7 \text{ V}; I_{OH} = -8 \text{ mA}$  |            | 2.4                   | 2.5                  | -     | V    |  |
|                     |                                       | $V_{CC} = 3.0 \text{ V}; I_{OH} = -32 \text{ mA}$   |            | 2.0                   | 2.2                  | -     | V    |  |
| / <sub>OL</sub>     | LOW-level output voltage              | $V_{CC}$ = 2.7 V; $I_{OL}$ = 100 $\mu$ A  |            | -                     | 0.1                  | 0.2   | V    |  |
|                     |                                       | $V_{CC} = 2.7 \text{ V}; I_{OL} = 24 \text{ mA}$  |            | -                     | 0.3                  | 0.5   | V    |  |
|                     |                                       | $V_{CC} = 3.0 \text{ V} \text{ I}_{OL} = 16 \text{ mA}$   |            | -                     | 0.25                 | 0.4   | V    |  |
|                     |                                       | $V_{CC} = 3.0 \text{ V} \text{ I}_{OL} = 32 \text{ mA}$   |            | -                     | 0.3                  | 0.5   | V    |  |
|                     |                                       | $V_{CC} = 3.0 \text{ V} \text{ I}_{OL} = 64 \text{ mA}$   |            | -                     | 0.4                  | 0.55  | V    |  |
| / <sub>OL(pu)</sub> | power-up LOW-level<br>output voltage  | $V_{CC}$ = 3.6 V; I <sub>O</sub> = 1 mA;<br>V <sub>I</sub> = GND or V <sub>CC</sub>   | [2]        | -                     | 0.13                 | 0.55  | V    |  |
| I                   | input leakage current                 | all input pins;   |            |                       |                      |       |      |  |
|                     |                                       | $V_{CC} = 0 V \text{ or } 3.6 V; V_{I} = 5.5 V$   |            | -                     | 1                    | 10    | μA   |  |
|                     |                                       | control pins;   |            |                       |                      |       |      |  |
|                     |                                       | $V_{CC}$ = 3.6 V; $V_{CC}$ or GND   |            | -                     | ±0.1                 | ±1    | μA   |  |
|                     |                                       | data pins   |            |                       |                      |       |      |  |
|                     |                                       | $V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC}$  | [3]        | -                     | 0.1                  | 1     | μA   |  |
|                     |                                       | $V_{CC} = 3.6 V; V_{I} = 0 V$   |            | -5                    | -1                   | -     | μA   |  |
| OFF                 | power-off leakage current             | $V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 0 V to 4.5 V   |            | -                     | 1                    | ±100  | μA   |  |
| BHL                 | bus hold LOW current                  | Dn input; $V_{CC}$ = 3 V; $V_I$ = 0.8 V   | [4]        | 75                    | 150                  | -     | μA   |  |
| внн                 | bus hold HIGH current                 | Dn input; $V_{CC} = 3 \text{ V}$ ; $V_I = 2.0 \text{ V}$  |            | -                     | -150                 | -75   | μA   |  |
| внно                | bus hold HIGH overdrive current       | Dn input; $V_{CC} = 3.6 \text{ V}$ ; $V_I = 0 \text{ V}$ to 3.6 V   | <u>[4]</u> | -                     | -                    | 500   | μA   |  |
| BHLO                | bus hold LOW overdrive current        | Dn input; $V_{CC} = 3.6 \text{ V}$ ; $V_I = 0 \text{ V}$ to 3.6 V   |            | -500                  | -                    | -     | μA   |  |
| LO                  | output leakage current                | Qn output HIGH when $V_{O}$ = 5.5 V and $V_{CC}$ = 3.0 V  |            | -                     | 60                   | 125   | μA   |  |
| O(pu/pd)            | power-up/power-down<br>output current | $ \begin{array}{l} V_{CC} \leq 1.2 \ V; \ V_{O} = \underline{0.5} \ V \ to \ V_{CC}; \\ V_{I} = GND \ or \ V_{CC}; \ \overline{OE} = don't \ care \end{array} $ | <u>[5]</u> | -                     | 1                    | ±100  | μA   |  |
| OZ                  | OFF-state output current              | $V_{CC}$ = 3.6 V; $V_I$ = $V_{IH}$ or $V_{IL}$  |            |                       |                      |       |      |  |
|                     |                                       | output HIGH: $V_0 = 3.0 V$  |            | -                     | 1                    | 5     | μA   |  |
|                     |                                       | output LOW: $V_0 = 0.5 V$   |            | -5                    | -1                   | -     | μA   |  |
| СС                  | supply current                        | $V_{CC}$ = 3.6 V; $V_{I}$ = GND or $V_{CC}$ ;<br>$I_{O}$ = 0 A  |            |                       |                      |       |      |  |
|                     |                                       | outputs HIGH  |            | -                     | 0.13                 | 0.19  | mA   |  |
|                     |                                       | outputs LOW   |            | -                     | 3                    | 12    | mA   |  |
|                     |                                       | outputs disabled  | [6]        | -                     | 0.13                 | 0.19  | mA   |  |

#### 3.3 V octal D-type transparent latch; 3-state

| Symbol          | Parameter                 | Conditions  | Conditions |     | T <sub>amb</sub> = -40 °C to +85 °C |     |    |
|-----------------|---------------------------|---|------------|-----|-------------------------------------|-----|----|
|                 |                           |   |            | Min | Typ <mark>[1]</mark>                | Max |    |
| $\Delta I_{CC}$ | additional supply current | per input pin; $V_{CC}$ = 3 V to 3.6 V;<br>one input at $V_{CC}$ – 0.6 V and other<br>inputs at $V_{CC}$ or GND | [7]        | -   | 0.1                                 | 0.2 | mA |
| CI              | input capacitance         | $V_{I} = 0 V \text{ or } 3.0 V$   |            | -   | 4                                   | -   | pF |
| Co              | output capacitance        | outputs disabled; $V_0 = 0$ V or 3.0 V  |            | -   | 8                                   | -   | pF |

#### Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] Typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

[2] For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.

- [3] Unused pins at  $V_{CC}$  or GND.
- [4] This is the bus hold overdrive current required to force the input to the opposite logic state.
- [5] This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 ms. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 3.3 V  $\pm$  0.3 V a transition time of 100  $\mu$ s is permitted. This parameter is valid for T<sub>amb</sub> = 25 °C only.
- [6]  $I_{CC}$  is measured with outputs pulled to  $V_{CC}$  or GND.
- [7] This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.

## **10. Dynamic characteristics**

#### Table 7.Dynamic characteristics

Voltages are referenced to ground (GND = 0 V); for test circuit see Figure 10.

| Symbol Parameter |                   | Conditions   | T <sub>amb</sub> : | =40 °C to            | +85 °C | Unit |
|------------------|-------------------|--|--------------------|----------------------|--------|------|
|                  |                   |  | Min                | Typ <mark>[1]</mark> | Max    |      |
| t <sub>PLH</sub> | LOW to HIGH       | LE to Qn; see Figure 5                             |                    |                      |        |      |
|                  | propagation delay | V <sub>CC</sub> = 3.0 V to 3.6 V                   | 1.9                | 3.1                  | 4.9    | ns   |
|                  |                   | V <sub>CC</sub> = 2.7 V                            | 2.6                | 3.7                  | 5.3    | ns   |
|                  |                   | Dn to Qn; see Figure 6                             |                    |                      |        |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                   | 1.9                | 3.0                  | 4.8    | ns   |
|                  |                   | V <sub>CC</sub> = 2.7 V                            | 2.6                | 3.4                  | 5.2    | ns   |
| t <sub>PHL</sub> | HIGH to LOW       | LE to Qn; see Figure 5                             |                    |                      |        |      |
|                  | propagation delay | V <sub>CC</sub> = 3.0 V to 3.6 V                   | 1.9                | 3.3                  | 4.7    | ns   |
|                  |                   | V <sub>CC</sub> = 2.7 V                            | 1.9                | 3.4                  | 5.0    | ns   |
|                  |                   | Dn to Qn; see Figure 6                             |                    |                      |        |      |
|                  |                   | V <sub>CC</sub> = 3.0 V to 3.6 V                   | 1.8                | 3.0                  | 4.8    | ns   |
|                  |                   | V <sub>CC</sub> = 2.7 V                            | 2.4                | 3.6                  | 5.0    | ns   |
| t <sub>PZH</sub> | OFF-state to HIGH | OE to Qn; see Figure 7                             |                    |                      |        |      |
|                  | propagation delay | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 1.8                | 3.4                  | 5.7    | ns   |
|                  |                   | $V_{CC} = 2.7 V$                                   | 3.0                | 4.5                  | 6.0    | ns   |
| t <sub>PZL</sub> | OFF-state to LOW  | OE to Qn; see Figure 8                             |                    |                      |        |      |
|                  | propagation delay | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | 1.9                | 3.3                  | 5.3    | ns   |
|                  |                   | $V_{CC} = 2.7 V$                                   | 2.7                | 4.0                  | 5.6    | ns   |

#### 3.3 V octal D-type transparent latch; 3-state

| Symbol Parameter                   |  | Conditions   | Conditions |     | = -40 °C to | +85 °C | Unit |
|------------------------------------|--|--|------------|-----|-------------|--------|------|
|                                    |  |  |            | Min | Typ[1]      | Max    |      |
| t <sub>PHZ</sub> HIGH to OFF-state |  | OE to Qn; see Figure 7                             |            |     | 1           |        |      |
| propagation delay                  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ |  | 1.8        | 3.2 | 5.1         | ns     |      |
|                                    | $V_{CC} = 2.7 V$                                   |  | 1.9        | 3.5 | 5.3         | ns     |      |
| t <sub>PLZ</sub> LOW to OFF-state  |  | OE to Qn; see Figure 8                             |            |     |             |        |      |
| propagation delay                  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ |  | 2.1        | 3.2 | 4.6         | ns     |      |
|                                    | $V_{CC} = 2.7 V$                                   |  | 2.0        | 3.0 | 4.6         | ns     |      |
| t <sub>su</sub> set-up time        | Dn to LE; see Figure 9                             | [2]  |            |     |             |        |      |
|                                    |  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ |            | 1.1 | -           | -      | ns   |
|                                    |  | $V_{CC} = 2.7 V$                                   |            | 1.0 | -           | -      | ns   |
| t <sub>h</sub>                     | hold time  | Dn to LE; see Figure 9                             | <u>[3]</u> |     |             |        |      |
|                                    |  | $V_{CC} = 3.0 V \text{ to } 3.6 V$                 |            | 1.4 | -           | -      | ns   |
|                                    |  | $V_{CC} = 2.7 V$                                   |            | 1.4 | -           | -      | ns   |
| t <sub>w</sub>                     | pulse width  | LE input HIGH; see Figure 5                        | [4]        |     |             |        |      |
|                                    |  | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ |            | 3.0 | -           | -      | ns   |
|                                    |  | $V_{CC} = 2.7 V$                                   |            | 3.0 | -           | -      | ns   |

#### Table 7. Dynamic characteristics ... continued

Voltages are referenced to ground (GND = 0 V); for test circuit see <u>Figure 10</u>.

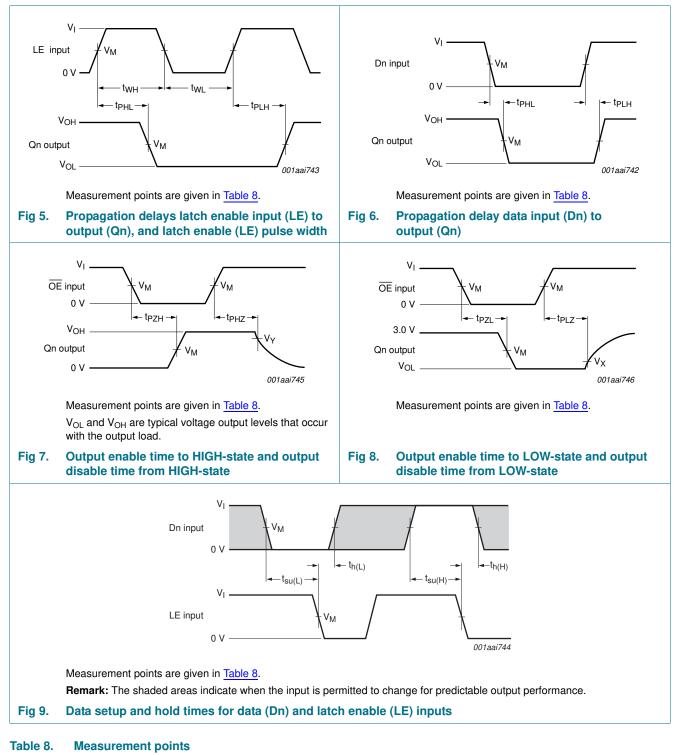
[1] Typical values are measured at  $T_{amb}$  = 25  $^\circ C$  and  $V_{CC}$  = 3.3 V and 2.7 V respectively.

 $[3] \quad t_h \text{ is the same as } t_{h(L)} \text{ and } t_{h(H)}.$ 

[4]  $t_W$  is the same as  $t_{WL}$  and  $t_{WH}$ .

#### 3.3 V octal D-type transparent latch; 3-state

### 11. Waveforms



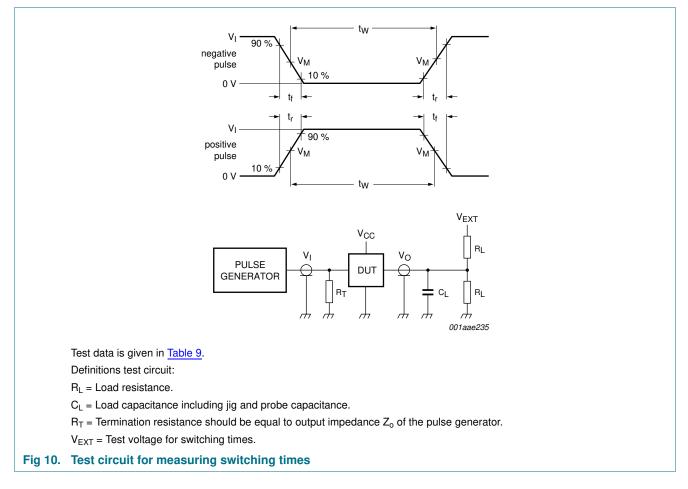
| Input          | Output         |                         |                  |
|----------------|----------------|-------------------------|------------------|
| V <sub>M</sub> | V <sub>M</sub> | V <sub>X</sub>          | V <sub>Y</sub>   |
| 1.5 V          | 1.5 V          | V <sub>OL</sub> + 0.3 V | $V_{OH} - 0.3 V$ |

74LVT373 Product data sheet

#### **NXP Semiconductors**

## 74LVT373

#### 3.3 V octal D-type transparent latch; 3-state



#### Table 9. Test data

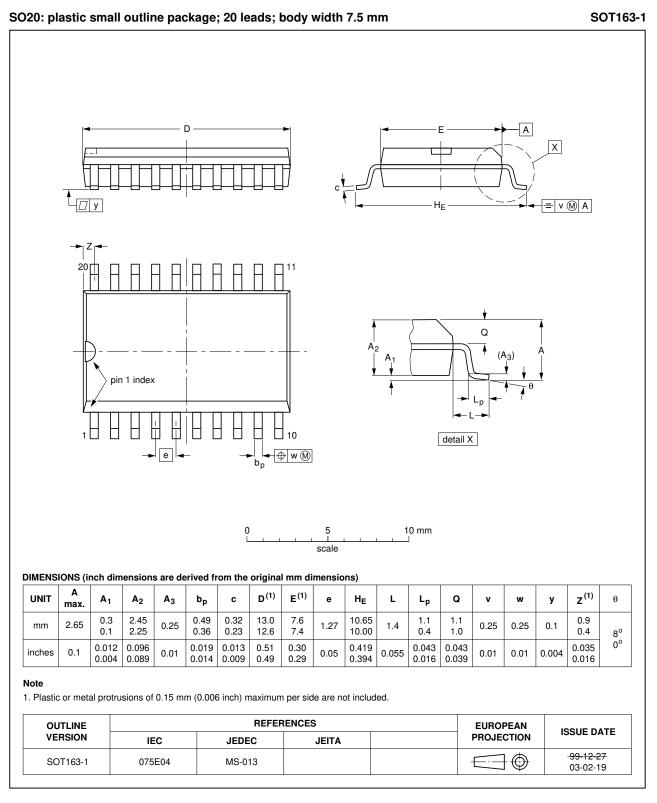
| Input L |                | Load   |                                 | V <sub>EXT</sub> |       |                                     |                                     |                                     |
|---------|----------------|--------|---------------------------------|------------------|-------|-------------------------------------|-------------------------------------|-------------------------------------|
| VI      | f <sub>i</sub> | tw     | t <sub>r</sub> , t <sub>f</sub> | CL               | RL    | t <sub>PHZ</sub> , t <sub>PZH</sub> | t <sub>PLZ</sub> , t <sub>PZL</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> |
| 2.7 V   | $\leq$ 10 MHz  | 500 ns | $\leq$ 2.5 ns                   | 50 pF            | 500 Ω | GND                                 | 6 V                                 | open                                |

#### **NXP Semiconductors**

## 74LVT373

3.3 V octal D-type transparent latch; 3-state

### 12. Package outline



#### Fig 11. Package outline SOT163-1 (SO20)

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3.3 V octal D-type transparent latch; 3-state

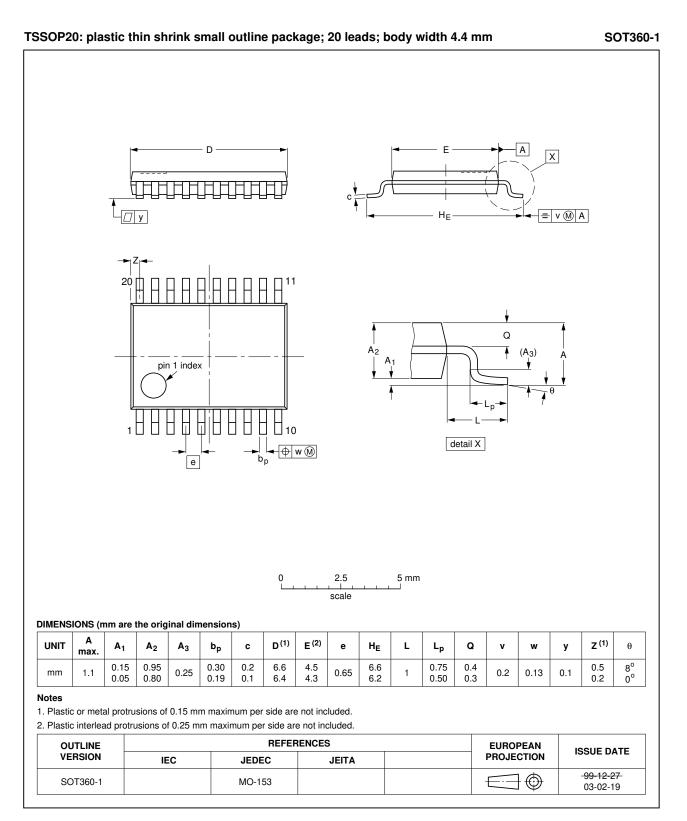


Fig 12. Package outline SOT360-1 (TSSOP20)

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## **13. Abbreviations**

| Abbreviations                                   |
|---|
| Description                                     |
| Bipolar Complementary Metal Oxide Semiconductor |
| Device Under Test                               |
| ElectroStatic Discharge                         |
| Human Body Model                                |
| Machine Model                                   |
| Transistor-Transistor Logic                     |
|   |

## 14. Revision history

| Table 11. Revision history |                                 |                    |               |              |  |
|----------------------------|---------------------------------|--------------------|---------------|--------------|--|
| Document ID                | Release date                    | Data sheet status  | Change notice | Supersedes   |  |
| 74LVT373 v.3               | 20111121                        | Product data sheet | -             | 74LVT373 v.2 |  |
| Modifications:             | <ul> <li>Legal pages</li> </ul> | updated.           |               |              |  |
| 74LVT373 v.2               | 20110916                        | Product data sheet | -             | 74LVT373 v.1 |  |
| 74LVT373 v.1               | 19930701                        | Product data sheet | -             | -            |  |

## 15. Legal information

#### 15.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### 3.3 V octal D-type transparent latch; 3-state

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#### 3.3 V octal D-type transparent latch; 3-state

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